

CONTACTS

Materials: Brass, BeCu, PhBz

Plating: T = 10 μ in. gold over nickel. TH = 50 μ in. gold over nickel (pins only). TAH = 50 μ in. gold over nickel (mating surface), & gold flash (socket bodies).

TABH = 50 μin. gold over nickel (mating surface),

gold flash (socket bodies)

& solder plate (termination area).

Resistance: < 8 milliohms. Current Rating: 2.5 amperes.

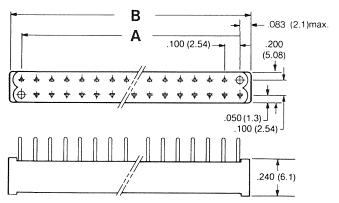
Extraction Force: Min. .3 oz., Max. 1.6 oz.

Life: >100,000 cycles.

Closed entry construction.

¹ No. of Contacts	Α	В
22	1.000 (25.4)	1.141 (28.99)
24	1.100 (27.94)	1.241 (31.53)
44	2.100 (53.34)	2.241 (56.93)
46	2.200 (55.88)	2.341 (59.47)
66	3.200 (81.28)	3.341 (84.87)
68	3.300 (83.82)	3.441 (87.41)
90	4.400 (111.76)	4.557 (115.76)

PIN CARRIER (A)



Notes:

- 1) These are standard size. Any even size from 2 to 90 can be specially ordered.
- 2) Dimensions in inches (mm).

HIGH DENSITY PIN & SOCKET P.C. BOARD STACKING CONNECTORS

- · Very low mating forces.
- · 2 styles:
 - -plug with pins to receptacles with sockets.
 - -pins (supplied on carrier) to receptacle with sockets.
- · Alignment and keying optional.
- Plugs and carriers have male contacts; receptacles have female contacts.
- .018 (.45) dia. pins.
- .100 (2.54) x .100 (2.54) centers.
- Stackable
- .240 height between boards.

CONNECTORS

Insulation Resistance at 500V dc:

>10⁵ M ohms.

Breakdown voltage between contacts:

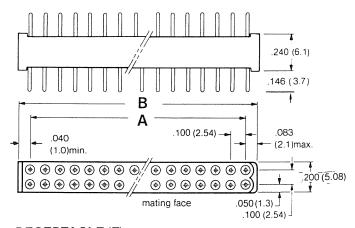
>1200 volts RMS.

Temperature Rating: -55°C to +105°C. Insulator Material: Nylon® (polyamide).

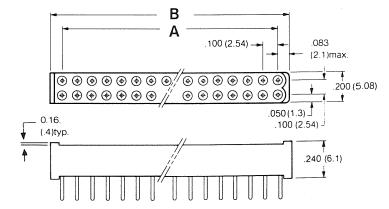
Guides: stainless steel or nickel plated brass.

CONNECTOR DIMENSIONS

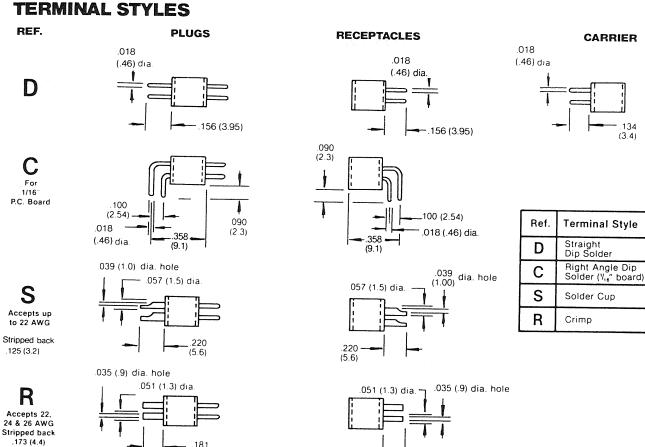
PLUG (P)



RECEPTACLE (E)



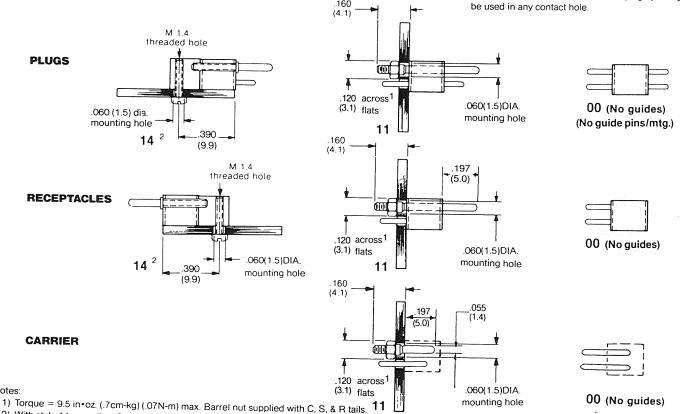
KG SERIES



.181 (4.6)

MOUNTING STYLES/ GUIDES/ KEYS

The guide pins serve the additional function of mounting by providing a threaded stud, and keying by being able to be used in any contact hole.

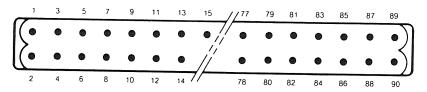


2) With style 14 mounting, 2 contact positions are used for each mounting position.

3) Dimensions in inches (mm).

CONTACT ARRANGEMENT

Receptacle seen from wiring side.

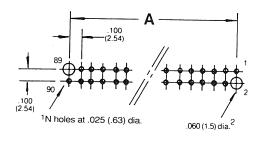


MOUNTING DIMENSIONS

MOTHER BOARD APPLICATION

STYLE 00, 11

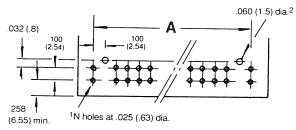
(Example has guide pins in position P2 and P89; although any combination is possible.)



DAUGHTER BOARD APPLICATION

STYLE 14

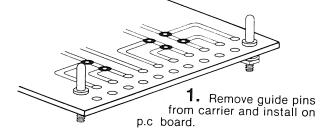
(Example has guide pins in position P3 and P87 although any combination is possible.)

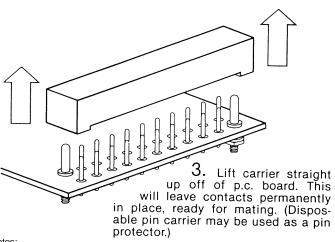


[.417 (10.6) to have board protrude for use as a pin protector]

No. of Contacts	Α
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24	1.100 (27.94)
44	2.100 (53.34)
46	2.200 (55.88)
66	3.200 (81.28)
68	3.300 (83.82)
90	4.400 (111.76)

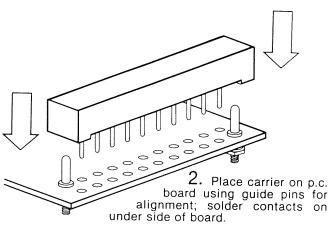
ASSEMBLY METHOD WITH PIN CARRIER (A)

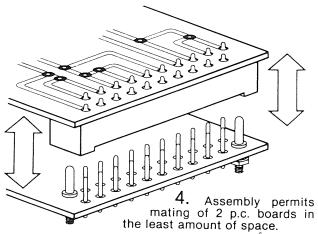




Notes:

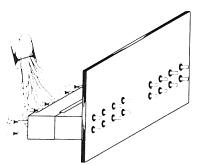
- 1) Number of contacts. (special pad configuration required next to mounting holes).
- 2) See pg. K40 for a description of mounting styles/guides/keys.
- 3) Dimensions in inches (mm).



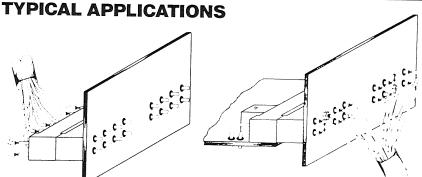


KG SERIES

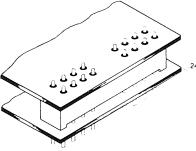
P.C. Board to P. C. Board -Thick Parallel Sandwich for tall board components [Mounting Style 00 to 00]



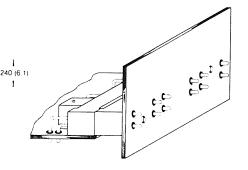
Cable to P.C. Board [Mounting Style 00 to 00]



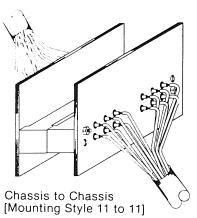
P.C. Board to Chassis [Mounting Style 14 to 11]



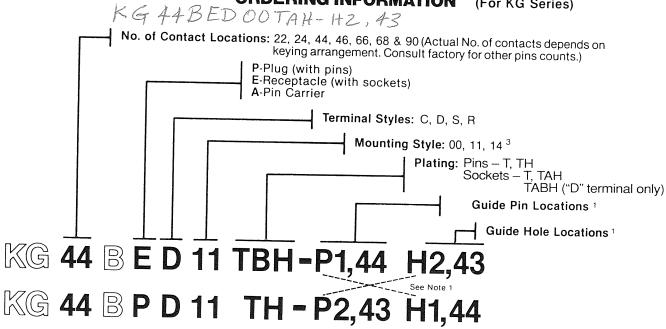
P.C. Board to P.C. Board — Thin Parallel Sandwich for maximum density [Mounting Style 00 to 00 (Carrier)]



Daughter Board to Mother Board [Mounting Style 14 to 00]



ORDERING INFORMATION (For KG Series)



ACCESSORIES

... S/Mont 1.0045 Comb for positioning right angle dip solder tails

SM **022-**001

No. of contact positions

- 1) If mounting/guiding/keying is desired, actual contact quantity will be reduced by the number of mounting/ guiding/keying positions (except 14, reduced by 2). For a mated pair, holes and guides must be complementary i.e., if position 1 in plug has guide pin then position 1 in receptacle must have guide hole, etc. If omitted, connectors will be shipped fully loaded without guides/mounts.
- 2) Dimensions in inches (mm).
- 3) With style 14 mounting, 2 contact positions are used for each